

GSM TELEPHONE SGH-E330N

SERVICE Manual

GSM TELEPHONE



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SAMSUNG ELECTRONICS



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BASIC.

1. Specification

1-1. GSM General Specification

	GSM900 Phase 1	DCS1800 Phase 1	PC1900 Phase 1
Freq. Band[MHz] Uplink/Downlink	890~915 935~960	1710~1785 1805~1880	1850~1910 1930~1990
ARFCN range	1~124	512~885	512~810
Tx/Rx spacing	45MHz	95MHz	80MHz
Mod. Bit rate/ Bit Period	270.833kbps 3.692us	270.833kbps 3.692us	270.833kbps 3.692us
Time Slot Period/Frame Period	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms
Modulation	0.3GMSK	0.3GMSK	0.3GMSK
MS Power	33dBm~5dBm	30dBm~0dBm	30dBm~0dBm
Power Class	5pcl ~ 19pcl	0pcl ~ 15pcl	0pcl ~ 15pcl
Sensitivity	-102dBm	-100dBm	-100dBm
TDMA Mux	8	8	8
Cell Radius	35Km	2 K m	-

1-2. GSM TX power class

TX Power control level	GSM900
5	33±3 dBm
6	31±3 dBm
7	29±3 dBm
8	27±3 dBm
9	25±3 dBm
10	23±3 dBm
11	21±3 dBm
12	19±3 dBm
13	17±3 dBm
14	15±3 dBm
15	13±3 dBm
16	11±5 dBm
17	9±5dBm
18	7±5 dBm
19	5±5 dBm

TX Power	
control level	DCS1800
0	30±3 dBm
1	28±3 dBm
2	26±3 dBm
3	24±3 dBm
4	22±3 dBm
5	20±3 dBm
6	18±3 dBm
7	16±3 dBm
8	14±3 dBm
9	12±4 dBm
10	10±4 dBm
11	8±4dBm
12	6±4 dBm
13	4±4 dBm
14	2±5 dBm
15	0±5 dBm

TX Power control level	PCS1900
0	30±3 dBm
1	28±3 dBm
2	26±3 dBm
3	24±3 dBm
4	22±3 dBm
5	20±3 dBm
6	18±3 dBm
7	16±3 dBm
8	14±3 dBm
9	12±4 dBm
10	10±4 dBm
11	8±4dBm
12	6±4 dBm
13	4±4 dBm
14	2±5 dBm
15	0±5 dBm

2. Circuit Description

2-1. SGH-E330N RF Circuit Description

2-1-1. RX PART

- ASM(U103) Switching Tx, Rx path for GSM900, DCS1800, PCS1900 by logic controlling.
- ASM Control Logic (U103) Truth Table

	VC1	VC2	VC3
GSM Tx Mode	Н	L	L
DCS Tx Mode	L	Н	L
PCS Tx Mode	Н	L	L
GSM Rx Mode	L	L	L
DCS Rx Mode	L	L	L
PCS Rx Mode	L	L	Н

- FILTER

To convert Electromagnetic Field Wave to Acoustic Wave and then pass the specific frequency band.

- GSM FILTER (F100) For filtering the frequency band between 869 and 894 MHz

- DCS FILTER (F102) For filtering the frequency band between 1805 and 1880 MHz.

- PCS FILTER (F101) For filtering the frequency band between 1930 and 1990 MHz.

- VC-TCXO (OSC100)

This module generates the 26MHz reference clock to drive the logic and RF. After division by two a reference clock of 13MHz is supplied to the other parts of the system through the pin CLKOUT. After additional process, the reference clock applies to the U100 Rx IQ demodulator and Tx IQ modulator. And then, the oscillator is controlled by serial data to select channel and use fast lock mode for GPRS high class operation.

- Transceiver (U100)

The receiver front-end which amplifies the GSM, DCS aerial signal, converts the chosen channel down to a low IF signal of 100 kHz. The first stages are symmetrical low noise amplifiers (LNAs). The LNAs are followed by an IQ down mixer. It consists of two mixers in parallel but driven by quadrature out of phase LO signals. The In phase (I) and Quadrature phase (Q) IF signals are low pass filtered to provide protection from high frequency offset interferes. The low IF I and Q signals are then fed into the channel filter. The front-end low IF I and Q outputs enter the integrated bandpass channel filter with provision for five 8 dB gain steps in front of the filter.

2-1-2. TX PART

I and Q baseband signals are applied to the IQ modulator that shifts the modulation spectrum up to the transmit IF. It is designed for low harmonic distortion, low carrier leakage and high image rejection to keep the phase error as small as possible.

The modulator is loaded at its IF output by an integrated low pass filter that suppress unwanted spurs prior to get into the phase detector. The clock drive is generated by division of the RFLO signal provided for the transmit offset mixer. Baseband IQ signal fed into offset PLL, this function is included inside of U100 chip. OSC101 chip generates modulator signal which power level is about 6.5dBm and fed into Power Amplifier(U102). The PA output power and power ramping are well controlled by Auto Power Control circuit. We use offset PLL below table.

Modulation Spectrum	200kHz offset 30 kHz bandwidth	GSM	-35dBc
		DCS	-35dBc
	400kHz offset	GSM	-66dBc
	30 kHz bandwidth	DCS	-65dBc
	600kHz ~ 1.8MHz offset	GSM	-75dBc
	30 kHz bandwidth	DCS	-68dBc

2-2. Baseband Circuit description of SGH-E330N

2-2-1. PCF50601

- Power Management

Ten low-dropout regulators designed specifically for GSM applications power the terminal and help ensure optimal system performance and long battery life. A programmable boost converter provides support for 1.8V, 3.0V, and 5.0V SIMs, while a self-resetting, electronically fused switch supplies power to external accessories. Ancillary support functions, such as RTC module and High Voltage Charge pump, Clock generator, aid in reducing both board area and system complexity. I2C BUS serial interface provides access to control and configuration registers. This interface gives a microprocessor full control of the PCF50601 and enables system designers to maximize both standby and talk times.

Supervisory functions including a reset generator, an input voltage monitor, and a temperature sensor, support reliable system design. These functions work together to ensure proper system behavior during start-up or in the event of a fault condition(low microprocessor voltage, insufficient battery energy, or excessive die temperature).

- Backlight Brightness Modulator

The Backlight Brightness Modulator (BBM) contains a programmable Pulse-width modulator (PWM) and FET to modulate the intensity of a series of LED's or to control a DC/DC converter that drives LCD backlight. But, this phone (SGH-E330N) is use UFB LCD. UFB LCD controls backlight brightness by contrast setting. So "BL_VDD" voltage is always high value when phone is in active mode. When phone is in dimming mode "BL_VDD" goes to about 10% duty PWM.

- Clock Generator

The Clock Generator (CG) generates all clocks for internal and external usage. The 32768 Hz crystal oscillator provides an accurate low clock frequency for the PCF50601 and other circuitry.

2-2-2. LCD Connector

LCD is consisted of main LCD(color 65K UFB LCD) and sub LCD (4Gray LCD).

Chip select signals LCD_MAIN_CS and LCD_SUB_CS, can enable Each LCD. BACKLIGHT signal enables white LED of main LCD. "RESET_2V8" signal initiates the reset process of the LCD.

16-bit data lines(LD(0)~LD(15)) transfers data and commands to LCD through bypass capacitor. Data and commands use "RS" signal. If this signal is high, inputs to LCD are commands. If it is low, inputs to LCD are data.

The signal which informs the state of LCD is whether input or output, is required. But in this system, there is no input state from LCD. So only "L_WR" signal is used to indicate write data or command to LCD. Power signals for LCD are "VBAT and "VDD2".

"M_SCL", "M_SCA", "PCLK", "FVALID", "LVALID" and "STANDBY" signals are all related to camera working. "CAMERA_FLASH_SUPPLY" is voltage supply to flash led , and "SVC_LED" is signal for service led when the signal is low led is on and vice versa. "SPK_P" and "SPK_N" are used for audio speaker containing voice or melody. And "VDD_VIB" from PCF50601 enables the motor.

2-2-3. Key

This is consisted of key interface pins among OM6359, KBIO(0:7). These signals compose the matrix. Result of matrix informs the key status to key interface in the OM6359. Power on/off key is separated from the matrix. So power on/off signal is connected with PCF50601 to enable PCF50601. Fifteen key LEDs are use the "VBAT" as supply voltage. "VDD_KEY" signal enables LEDs. "FLIP" informs the status of folder (open or closed) to the OM6359. This uses the hall effect IC, SH248CSP. A magnet under main LCD enables SH248CSP.

2-2-4. EMI ESD Filter

This system uses the EMI ESD filter, EMIF09 to protect noise from IF CONNECTOR part.

2-2-5. IF connetor

It is 18-pin connector. They are designed to use VBAT, V_EXT_CHARGE, TXD0, RXD0, RTS0, CTS0, JIG_REC, CHARGER_OK, RXD1, TXD1, AUX_MIC, AUX_SPK and GND. They connected to power supply IC, microprocessor and signal processor IC.

2-2-6. Battery Charge Management

A complete constant-current/constant-voltage linear charger is used for single cell lithium-ion batteries. If TA connected to phone, "V_EXT_CHARGE" enable charger IC and supply current to battery. When fault condition caused, "CHG_ON" signal level change low to high and charger IC stop charging process.

2-2-7. Audio

EARP_P and EARP_N from OM6359 are connected to the main speaker. AUXSP is connected to the Hands free kit. MIC_P and MIC_N are connected to the main MIC. And AUX_MIC_P and AUX_MIC_N are connected to the Hands free kit.

YMU762C is a LSI for portable telephone that is capable of playing high quality music by utilizing FM synthesizer and ADPCM decoder that are included in this device.

As a synthesis, YMU762C is equipped 32 voices with different tones. Since the device is capable of simultaneously generating up to synchronous with the play of the FM synthesizer, various sampled voices can be used as sound effects. Since the play data of YMU762C are interpreted at anytime through FIFO, the length of the data(playing period) is not limited, so the device can flexibly support application such as incoming call melody music distribution service. The hardware sequencer built in this device allows playing of the complex music without giving excessive load to the CPU of the portable telephones.

Moreover, the registers of the FM synthesizer can be operated directly for real time sound generation, allowing, for example, utilization of various sound effects when using the game software installed in the portable telephone. YMU762C includes a speaker amplifier with high ripple removal rate whose maximum output is 550mW (SPVDD=3.6V). The device is also equipped with conventional function including a vibrator and a circuit for controlling LEDs synchronous with music.

For the headphone, it is provided with a stereophonic output terminal.

For the purpose of enabling YMU762C to demonstrate its full capabilities, Yamaha purpose to use "SMAF:Synthetic music Mobile Application Format" as a data distribution format that is compatible with multimedia. Since the SMAF takes a structure that sets importance on the synchronization between sound and images, various contents can be written into it including incoming call melody with words that can be used for training karaoke, and commercial channel that combines texts, images and sounds, and others. The hardware sequencer of YMU762C directly interprets and plays blocks relevant to synthesis (playing music and reproducing ADPCM with FM synthesizer) that are included in data distributed in SMAF.

2-2-8. Memory

Signals in the OM6359 enable two memories. They use only one volt supply voltage, VDD3 in the PCF50601. This system uses Samsung's memory, KBB06A500M-T402. It is consisted of 128M bits flash NOR memory and 128M bits flash NAND memory and 64M bits SCRAM. It has 16 bit data line, HD[0~15] which is connected to OM6359 and MV317S. It has 26 bit address lines, HA[1~26]. CS_NAND and NCSRAM signals are chip select. Writing process, HWR_N is low and it enables writing process to flash memory and SRAM. During reading process, HRD_N is low and it enables reading process to flash memory and SRAM. Each chip select signals in the OM6359 select memory among 2 flash memory and SCRAM. Reading or writing procedure is processed after HWR_N or HRD_N is enabled. Memories use reset, which is VDD3 delay from PCF50601. HA[25] signal enables lower byte of SRAM and HA[26] signal enables higher byte of SRAM.

2-2-9. OM6359

OM6359 is consisted of ARM core and DSP core. It has 8x1Kword on-chip program/data RAM, 55 Kwords on-chip program ROM in the DSP. It has 4K*32bits ROM and 2K*32bits RAM in the ARM core. DSP is consisted of KBS, JTAG, EMI and UART. ARM core is consisted of EMI, PIC(Programmable Interrupt Controller), reset/power/clock unit, DMA controller, TIC(Test Interface Controller), peripheral bridge, PPI, SSI(Synchronous Serial Interface), ACC(Asynchronous communications controllers), timer, ADC, RTC(Real-Time Clock) and keyboard interface. KBIO(0:7), address lines of DSP core and HD[0~15]. HA[1~26], address lines of ARM core and HD[0~15], data lines of ARM core are connected to memory, YMU762C. MV317S(Camera DSP Chip) controls the communication between ARM core and DSP core.

CS_NAND, NCSRAM, NCSFLASH in the ARM core are connected to each memory. HWR_N and HRD_N control the process of memory. External IRQ(Interrupt ReQuest) signals from each units, such as, PMU need the compatible process. KBIO[0~7] receive the status from key and RXD0/TXD0 are used for the communication using data link cable(DEBUG_DTR/RTS/TXD/RXD/CTS/DSR).

It has JTAG control pins(TDI/TDO/TCK) for ARM core and DSP core. It receives 13MHz clock in CKI pin from external TCXO. ADC(Analog to Digital Convertor) part receives the status of temperature, battery type and battery voltage.

2-2-10. TOH2600DGI4KRA(26MHz)

This system uses the 26MHz TCXO, TOH2600DGI4KRA, SEM. AFC control signal from OM6359 controls frequency from 26MHz x-tal. The clock output frequency of UAA3536 is 13MHz. This clock is connected to OM6359, YMU762C.

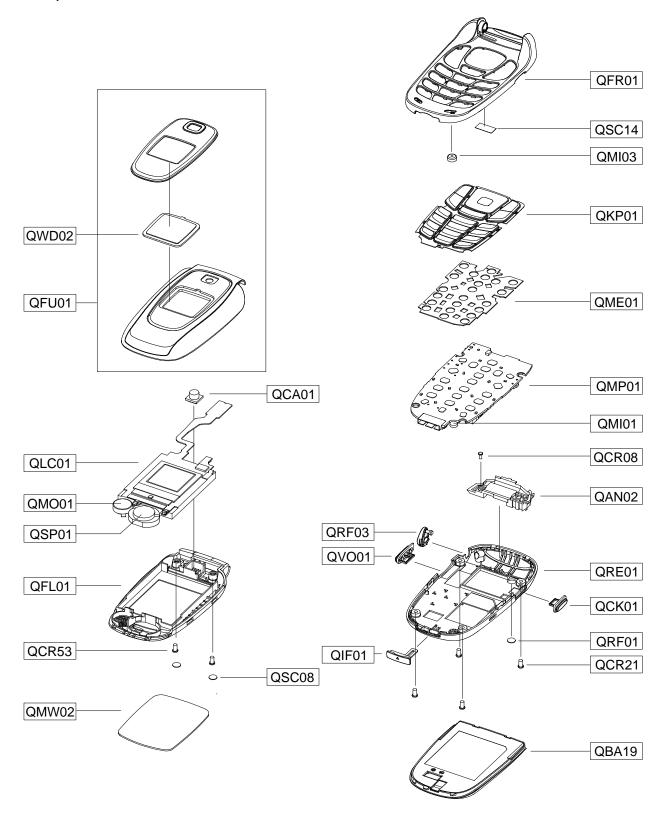
2-2-11. Camera DSP(MV3018SAQ)

MV3018 is a Camera Control Processor providing the most efficient camera functions for portable terminal devices such as mobile handsets. MV3018 provides rich video functions up to 30-frame display with minimized tasks in the handset main processor as well as hardware based real-time JPEG compression and decompression. MV3018 directly transmits and previews the RGB data to the LCD graphic memory by processing the sensor output data according to the cell phone's command. MV3018 can allow the host processor to download with scalable sized compressed data. In addition, MV3018 can download the compressed image to either store the original RGB data or transfer the image to the LCD. This feature allows the main processor to minimize its function while obtaining the result of the image process. MV3018 can support sensors up to 300K pixels.

The main processor to minimize its function while obtaining the result of the image process. MV3018 can support sensors up to VGA pixels.

3. Exploded Views and Parts List

3-1. Exploded View



3-2. Parts List

Location	No	Description	SEC Code
QAN02		INTENNA-SGHE330N; IAPTOGDP3815SC,SGH-	GH42-00623A
QBA19		BATTERY-800MAH,ANT SIL,EU,M;BST5068S	GH43-01988A
QCA01		UNIT-CAMERA; SGH-E335, MOMFH150G2A, -, U	GH59-02050A
QCK01		MEC-CAMERA KEY ASSY; SGH-X640, XEF, -, -	GH75-06567A
QCR08		SCREW-MACHINE; CH, +, M1.4, L3, BLK, SWRCH	6001-001456
QCR21		SCREW-MACHINE; BH(1.0), +, M1.7, L3.5, BL	6001-001507
QCR53		SCREW-MACHINE; CH, +, M1.7, L5, ZPC(BLK),	6001-001639
QFL01		MEC-FOLDER LOWER; SGH-E330N, EU, -, -, -,	GH75-07535A
QIF01		PMO-IF COVER; SGH-E330N, PC+RUBBER, SIL	GH72-23262A
QKP01		MEC-KEYPAD; SGH-E330N,EU,-,-,-,SIL,	GH75-07639A
QLC01		LCD-SGHE335 MAIN MODULE; UG-12R110-C,	GH07-00689A
QME01		UNIT-METAL DOME; SGH-E330N,-,-,XET,12	GH59-02405A
QMI01		MICROPHONE-ASSY; 2,130~500uA,-44dB,2.	GH30-00130A
QMO01		MOTOR-DC; 12000rpm,0g.cm,3V,80mA	3101-001401
QMP01		PBA MAIN-SGHE330N; SGH-E330N, XEF, UNKD	GH92-02281A
QMW02		PCT-MAIN WINDOW; SGH-E330N, ACRYLIC, TR	GH72-23488A
QRE01		MEC-REAR COVER; SGH-E330N, EU, -, -, -, -,	GH75-07536A
QRF01		MPR-RF SHEET; SGH-X640, PET+TESA 4972,	GH74-13063A
QSC08		MPR-SCREW SHEET L; SGH-E330N,PC SHEET	GH74-16222A
QSC14		MPR-TAPE FRONT FPC;SGH-E330,3M 1352	GH74-08876A
QSP01		SPEAKER; 0.8W,80hm,86,750Hz±20%	3001-001731
QV001		MEC-VOLUME KEY ASSY; SGH-X640, XEF, -, -	GH75-06566A
QFU01		MEC-FOLDER UPPER; SGH-E330N,EU,-,-,-,	GH75-07534A
(QWD02	PCT-WINDOW DUAL; SGH-E335, ACRYL, TRP, -	GH72-19294A
QFR01		MEC-FRONT COVER; SGH-E330N, EU, -, -, -, -	GH75-07547A
	QRF03	PMO-EAR COVER; SGH-E330N, PC, SIL, -, -, -	GH72-19199F
	QMI03	RMO-MIC RUBBER; SGH-X640,UR RUBBER,7X	GH73-04064A

Description	SEC Code
BAG PE;LDPE,T0.05,W80,L180,TRP,-,-	6902-000634
ADAPTOR-TAD; TAD137ESE, SGH-P100,-,110	GH44-00482A
UNIT-EARPHONE; SGH-C200, AEP299SLE, -, E	GH59-01694A
SPRING ETC-LOCKER; SGH-T108, KSD3509,0	GH61-00028A
LABEL(P)-WATER SOAK; COMM, NORGE, 100G,	GH68-02026A
MANUAL-SFC LEAFLET; COMM, XEE, ENGLISH,	GH68-06655A
MANUAL-SFC CARD; COMM, XEE, ENGLISH, NOW	GH68-06656A
MANUAL-WEEE CARD; COMM, SEC, ENGLISH, UN	GH68-07013A
LABEL(R)-MAIN(EU); SGH-E330N,CHAN,POL	GH68-07492A
MANUAL-USER; SGH-E330N, XEE, SWEDISH, SW	GH68-08465A
MANUAL-USER; SGH-E330N, XEE, NORWEGIAN,	GH68-08466A
MANUAL-USER; SGH-E330N, XEE, DANISH, DNM	GH68-08467A
MANUAL-USER; SGH-E330N, XEE, FINNISH, FI	GH68-08468A
CUSHION-CASE; SGH-E630, PULP, TO.8, 185,	GH69-02409A
BOX(P)-UINIT(EU);SGH-E330N,SC300+S12	GH69-03103A
PMO-BATT LOKER; SGH-E330N, PC, SIL, -, -,	GH72-19203F
MPR-F/LOWER BOHO VINYL; SGH-S500,3M 4	GH74-05004A
MPR-LOWER FINAL PROTECT; SCH-E510, VIN	GH74-08502A
MPR-TAPE WINDOW MAIN; SGH-E330, 3M-949	GH74-08864A
MPR-TAPE DOME SHEET; SGH-E330, GOLD FA	GH74-10850A
MPR-TAPE WINDOW DUAL; SGH-E335,3M 949	GH74-12787A
MPR-LCD TAPE SHOT;SGH-E335,3M 1352 B	GH74-14727A
MPR-LCD TAPE GAP;SGH-E335,DPF-100,32	GH74-14728A
MPR-TAPE LCD BIT;SGH-E335,3M 851,26X	GH74-14729A
MPR-TAPE LCD MAIN; SGH-E335, DPF-100 C	GH74-14955A
MPR-BOHO VINYL LCD CONN; SGH-E730,#95	GH74-15350A
MPR-GASKET L;SGH-E330N,GASKET SPONGE	GH74-16546A
MPR-GASKET R;SGH-E330N,GASKET SPONGE	GH74-16547A
MPR-TAPE PBA;SGH-E330N,TPF-100,3.5X4	GH74-16734A
MEC-HAND STRAP; SGH-E620, SEC, -, -, ANTI	GH75-03207U

3-3. Test Jig (GH80-01909A)



3-3-1. RF Test Cable (GH39-00283A)



3-3-2. Test Cable (GH39-00217A)



3-3-3. Serial Cable



3-3-4. Power Supply Cable



3-3-5. DATA CABLE (GH39-00219A)



3-3-6. TA (GH44-00482A)



4. Electrical Parts List

Design LOC	Description	SEC CODE	STATUS
BAT30	BATTERY-LI(2ND)	4302-001157	SA
C100	C-CER,CHIP	2203-005482	SA
C101	C-CER,CHIP	2203-005057	SA
C102	C-CER,CHIP	2203-005057	SA
C103	C-CER,CHIP	2203-005482	SA
C104	C-CER,CHIP	2203-000995	SA
C105	C-CER,CHIP	2203-005138	SA
C106	C-CER,CHIP	2203-000359	SA
C107	C-CER,CHIP	2203-000836	SA
C108	C-CER,CHIP	2203-005482	SA
C109	C-CER,CHIP	2203-000812	SA
C110	C-CER,CHIP	2203-001101	SA
C111	C-CER,CHIP	2203-000854	SA
C112	C-CER,CHIP	2203-000812	SA
C113	C-CER,CHIP	2203-005057	SA
C114	C-CER,CHIP	2203 - 005482	SA
C115	C-CER,CHIP	2203 000402	SA
C116	C-CER,CHIP	2203-000854	SA
C117	C-CER,CHIP	2203-000812	SA
C118	C-CER,CHIP	2203 - 005496	SA
C119	C-CER,CHIP	2203 - 000438	SA
C120	C-CER,CHIP	2203-000438	SA
C121	C-CER,CHIP	2203-000438	SA
C121	C-CER,CHIP	2203-000278	SA
C122	C-CER,CHIP	2203-000496	SA
C123	C-CER,CHIP	2203-000233	SA
			SA
C125	C-CER,CHIP	2203-006053	
C126	C-CER,CHIP	2203-000254	SA
C127	C-CER,CHIP	2203-005482	SA
C128	C-CER,CHIP	2203-005057	SA
C129	C-CER,CHIP	2203-005057	SA
C130	C-CER,CHIP	2203-005482	SA
C131	C-CER,CHIP	2203-000233	SA
C132	C-CER,CHIP	2203-001153	SA
C133	C-CER,CHIP	2203-000604	SA
C134	C-CER,CHIP	2203-000854	SA
C135	C-CER,CHIP	2203-000278	SA
C136	C-CER,CHIP	2203-000585	SA
C137	C-CER,CHIP	2203-000585	SA
C138	C-CER,CHIP	2203-000585	SA
C139	C-CER,CHIP	2203-000585	SA
C141	C-TA,CHIP	2404-001239	SA
C142	C-CER,CHIP	2203-000254	SA
C144	C-CER,CHIP	2203-000812	SA
C145	C-CER,CHIP	2203-000233	SA
C146	C-CER,CHIP	2203-000233	SA
C147	C-CER,CHIP	2203-001383	SA
C148	C-CER,CHIP	2203-000311	SA
C149	C-CER,CHIP	2203-000585	SA
C150	C-CER,CHIP	2203-002443	SA

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Design LOC	Description	SEC CODE	STATUS
C151	C-CER,CHIP	2203-005053	SA
C152	C-CER,CHIP	2203-000438	SA
C153	C-CER,CHIP	2203-001153	SA
C155	C-CER,CHIP	2203-000438	SA
C156	C-CER,CHIP	2203-000438	SA
C200	C-CER,CHIP	2203-005061	SA
C202	C-CER,CHIP	2203-005482	SA
C203	C-CER,CHIP	2203-005061	SA
C204	C-CER,CHIP	2203-000679	SA
C205	C-CER,CHIP	2203-000995	SA
C206	C-CER,CHIP	2203 - 000254	SA
C207	C-CER,CHIP	2203 - 005482	SA
C208	C-CER,CHIP	2203 - 000254	SA
C209	C-CER,CHIP	2203 - 000234	SA
C210	C-CER,CHIP	2203-005482	SA
C210	C-CER,CHIP	2203-005482	SA
C211	C-CER,CHIP	2203-005482	SA
C212	C-CER,CHIP	2203-006093	SA
C214 C215	<u> </u>		SA
	C-CER,CHIP	2203-005482	
C300	C-CER,CHIP	2203-000233	SA
C301	C-CER,CHIP	2203-000679	SA
C302	C-CER,CHIP	2203-005061	SA
C303	C-CER,CHIP	2203-000438	SA
C304	C-CER,CHIP	2203 - 005061	SA
C305	C-CER,CHIP	2203-005496	SA
C306	C-CER,CHIP	2203-006208	SA
C307	C-CER,CHIP	2203-005061	SA
C308	C-CER,CHIP	2203-001432	SA
C309	C-CER,CHIP	2203-002687	SA
C310	C-CER,CHIP	2203-005483	SA
C312	C-CER,CHIP	2203-006208	SA
C313	C-CER,CHIP	2203-005061	SA
C314	C-CER,CHIP	2203-000254	SA
C315	C-CER,CHIP	2203-005061	SA
C316	C-CER,CHIP	2203-000330	SA
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C319	C-CER,CHIP	2203-006053	SA
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Design LOC	Description	SEC CODE	STATUS
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C600	C-CER,CHIP	2203-003001	SA
C602	C-CER,CHIP	2203-000330	SA
C603	C-CER,CHIP	2203-000993	SA
C604	C-CER,CHIP	2203-005061	SA
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C625	C-CER,CHIP	2203-000812	SA
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C704	C-CER,CHIP	2203-001437	SA
CN400	CONNECTOR-CARD EDGE	3709-001273	SA
CN500	CONNECTOR-INTERFACE	3710-001994	SA

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CN502	CONNECTOR-COAXIAL	3705-001355	SA
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F100	FILTER-SAW	2904-001469	SA
F101	FILTER-SAW	2904-001537	SA
F102	FILTER-SAW	2904-001540	SA
F103	FILTER-EMI SMD	2901 - 001254	SA
F700	FILTER-EMI SMD	2901-001286	SA
F701	FILTER-EMI SMD	2901-001286	SA
F702	FILTER-EMI SMD	2901 - 001286	SA
F703	FILTER-EMI SMD	2901 - 001286	SA
F704	FILTER-EMI SMD	2901 - 001286	SA
F705	FILTER-EMI SMD	2901 - 001286	SA
HDC70	HEADER-BOARD TO BOARD	3711-005551	SA
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L101	INDUCTOR-SMD	2703-001613	SA
L102	INDUCTOR-SMD	2703-001728	SA
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L104	INDUCTOR-SMD	2703-002267	SA
L105	INDUCTOR-SMD	2703-002199	SA
L106	INDUCTOR-SMD	2703 -001748	SA
L107	INDUCTOR-SMD	2703 001740	SA
L109	INDUCTOR-SMD	2703-001722	SA
L110	INDUCTOR-SMD	2703-002204	SA
L111	R-CHIP	2007-000171	SA
L112	INDUCTOR-SMD	2703-00171	SA
L113	INDUCTOR-SMD	2703-001723	SA
L114	INDUCTOR-SMD	2703-001723	SA
L620	BEAD-SMD	3301-001729	SA
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LED70	LED		SA
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OSC10	OSCILLATOR - VCTCXO	2809-001294	SA
OSC30	CRYSTAL-SMD	2801 - 004285	SA
Q700	TR-DIGITAL	0506-000107	SA
R100	R-CHIP	2007-007148	SA
R101	R-CHIP	2007-000141	SA
R102	R-CHIP	2007 - 007528	SA

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Design LOC	Description	SEC CODE	STATUS
R103	R-CHIP	2007-000566	SA
R104	R-CHIP	2007-003010	SA
R105	R-CHIP	2007-007142	SA
R106	R-CHIP	2007-007311	SA
R107	R-CHIP	2007-001313	SA
R108	R-CHIP	2007-001313	SA
R109	R-CHIP	2007 - 000566	SA
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R112	R-CHIP	2007 - 008117	SA
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R305	R-CHIP	2007 - 000133	SA
R306	R-CHIP	2007-00171	SA

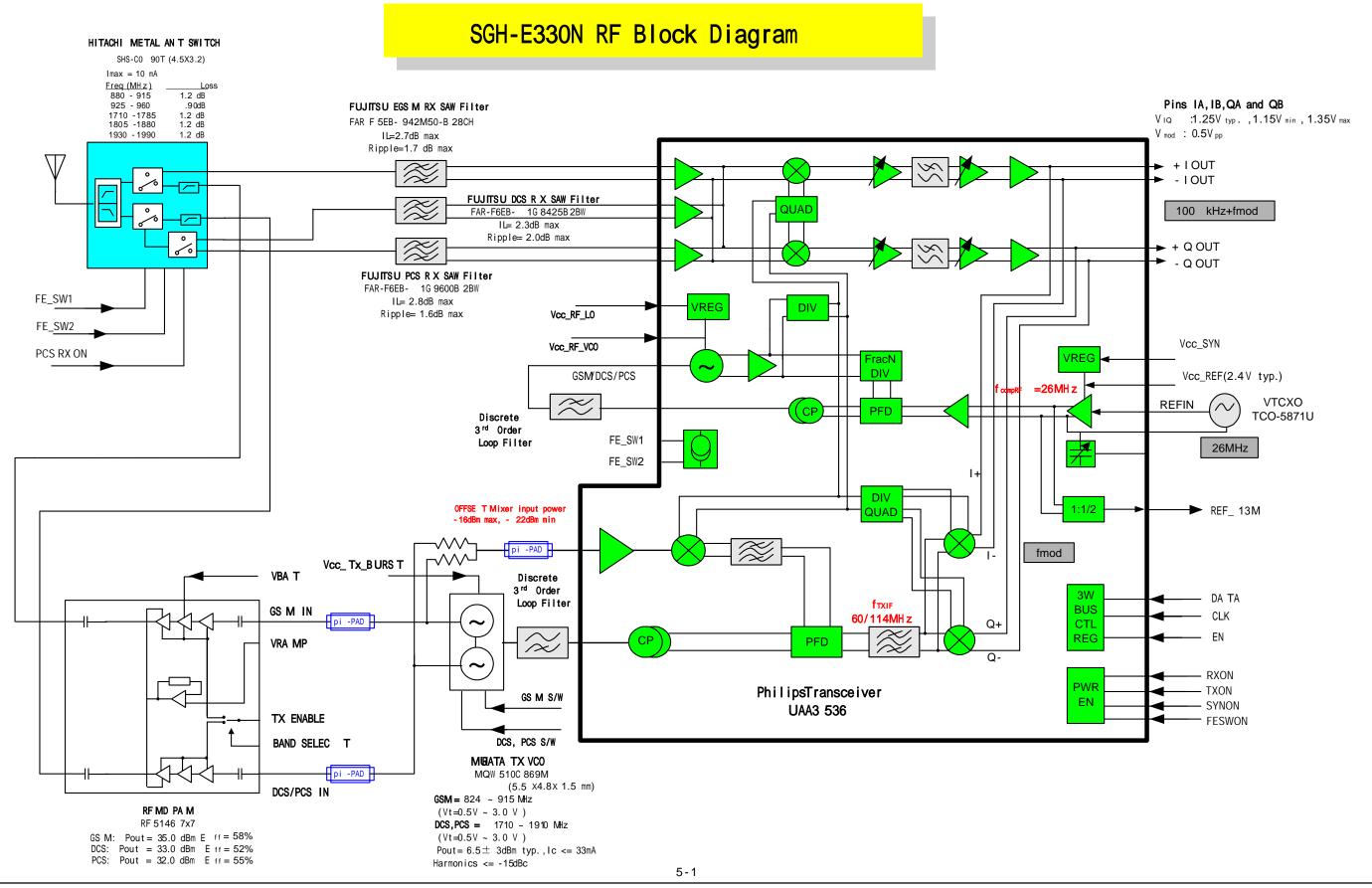
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R715		2007 - 000174	
R716 R719	R-CHIP R-CHIP	2007 - 000174 2007 - 008672	SA SA

4-6

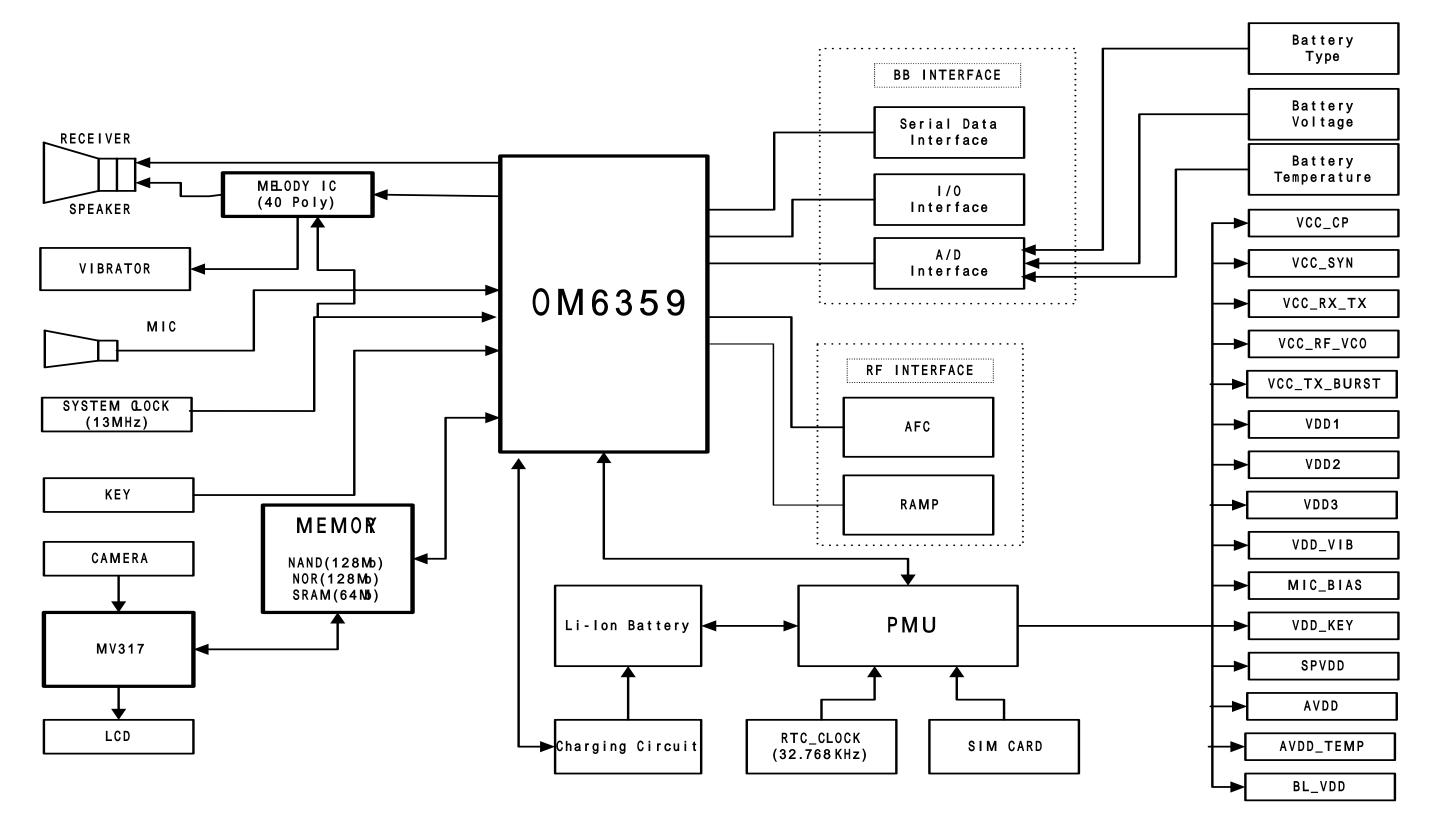
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THERMISTOR-NTC	1404-001221	SA
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VARISTOR	1405-001082	SA
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		SA
DIODE - 1 42	0400-001194	SA
	SWITCH-TACT IC-HALL EFFECT S/W SWITCH-TACT SWITCH-TACT THERMISTOR-NTC IC-TRANSCEIVER IC-POWER AMP DUPLEXER-ASM IC ASIC-SCHN480 IC-CMOS LOGIC IC-MELODY IC-MCP IC-MCP IC-MOS LOGIC IC-MULTI REG. IC-POSI.FIXED REG. IC-CONTROLLER FILTER-EMI/ESD IC-BATTERY IC-ANALOG MULTIPLEX IC-POSI.FIXED REG. C-CER,CHIP IC-COMM. CONTROLLER VARISTOR	SWITCH-TACT 3404-001152 IC-HALL EFFECT S/W 1009-001018 SWITCH-TACT 3404-001152 SWITCH-TACT 3404-001152 SWITCH-TACT 3404-001152 THERMISTOR NTC 1404-001221 IC-TRANSCEIVER 1205-002327 IC-POWER AMP 1201-002174 DUPLEXER-ASM 2909-001246 IC-ASIC-SCHN480 GH13-00029A IC-CMOS LOGIC 0801-002882 IC-CMOS LOGIC 0801-002882 IC-MELODY 1204-002161 IC-MCP 1109-001316 IC-MCP 1109-001316 IC-MCP 1109-001316 IC-MCP 1109-00136 IC-MOS LOGIC 0801-002882 IC-CMOS LOGIC 0801-002882 IC-MULTI REG. 1203-003459 IC-POSI-FIXED REG. 1203-003468 IC-SONTROLLER 1205-002350 FILTER-EMI/ESD 2901-001246 IC-BATTERY 1203-003486 IC-SATTERY 1203-003486 IC-VOLTAGE COMP. 1202-001036 IC-POSI-FIXED REG. 1203-001917 IC-VOLTAGE COMP. 1202-001036 IC-POSI-FIXED REG. 1203-001917 IC-

5. Block Diagrams

5-1. RF Solution Block Diagram

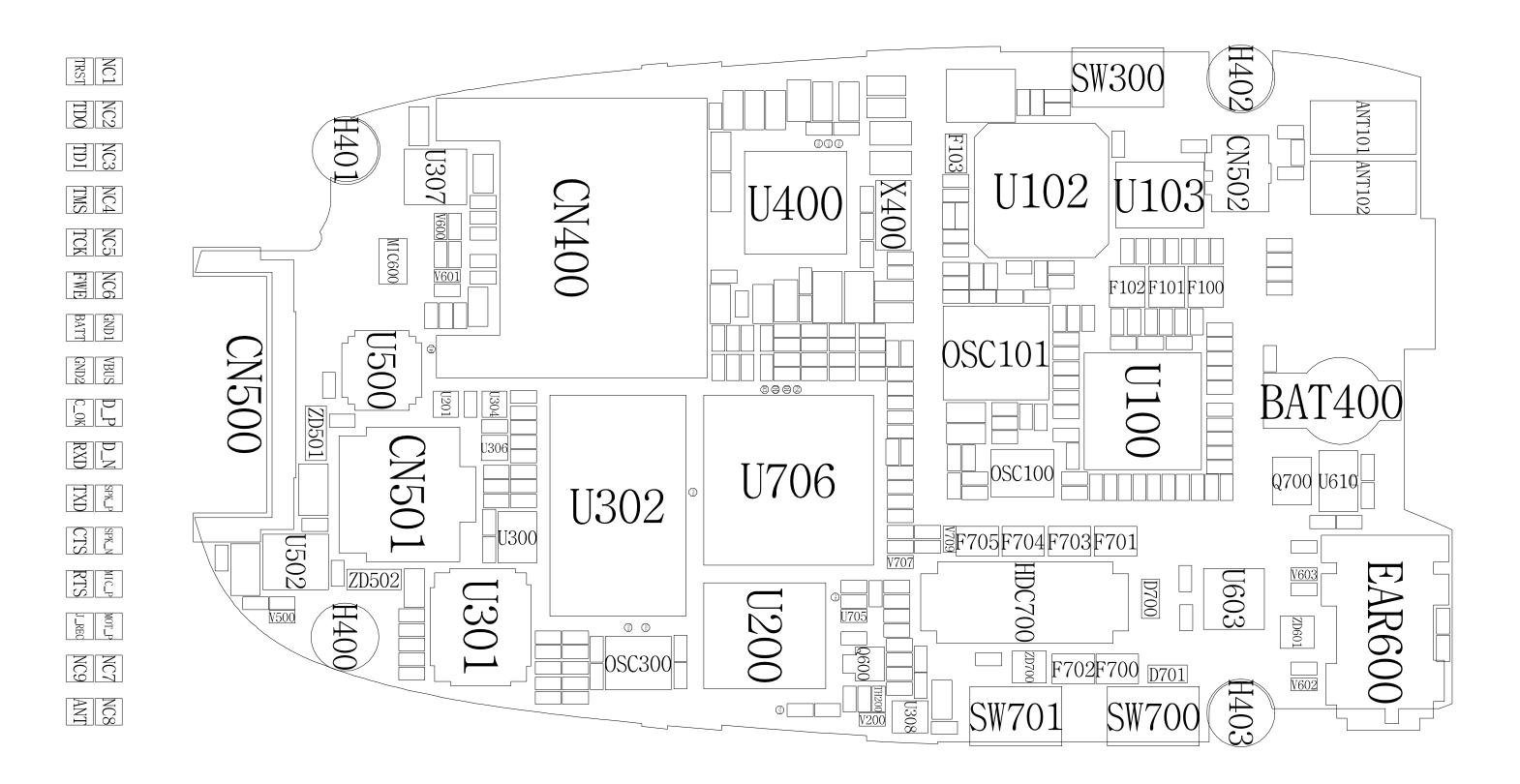


5-2. Base Band Solution Block Diagram

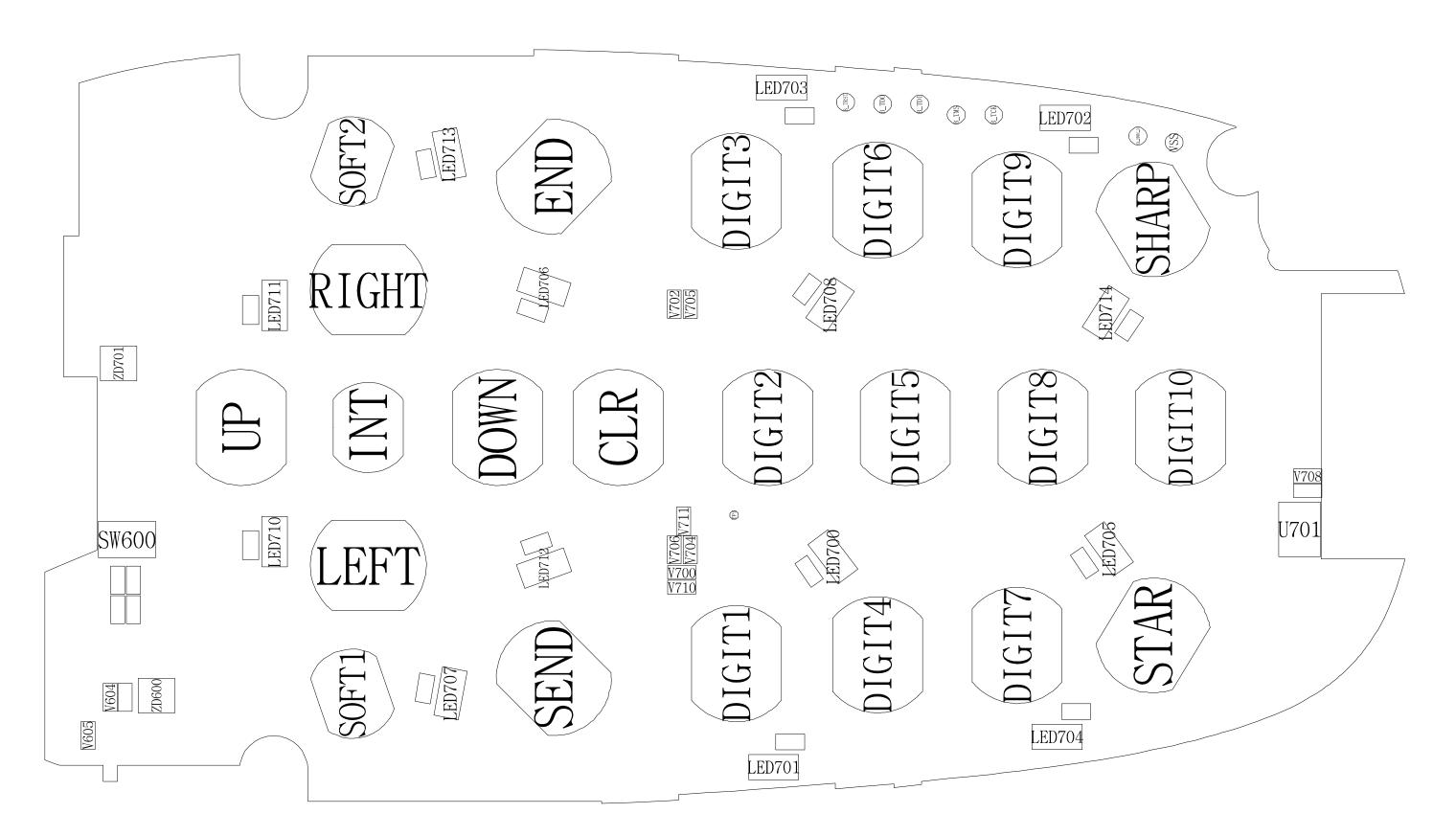


BB Block Diagram of SGH-E330N

6-1. PCB Top Diagram

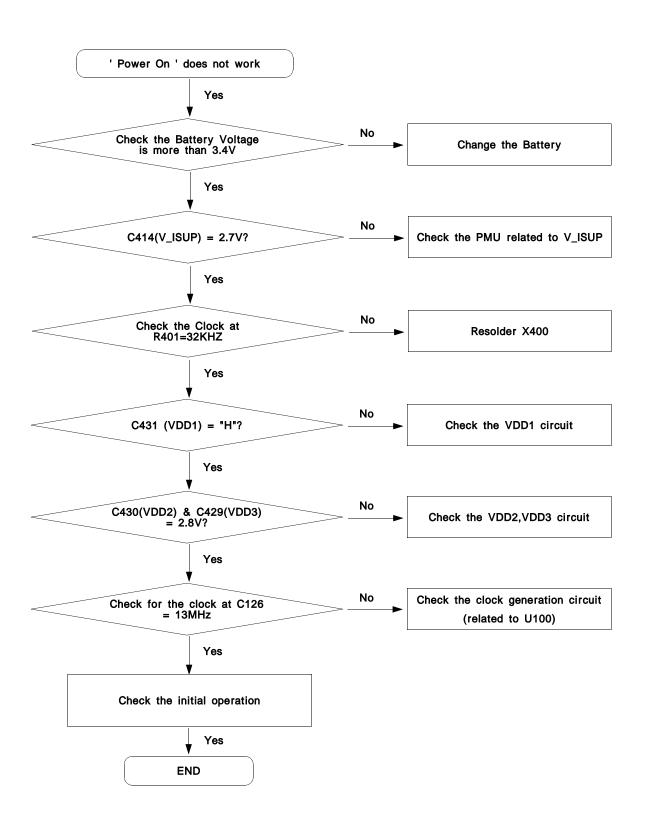


6-2. PCB Bottom Diagram

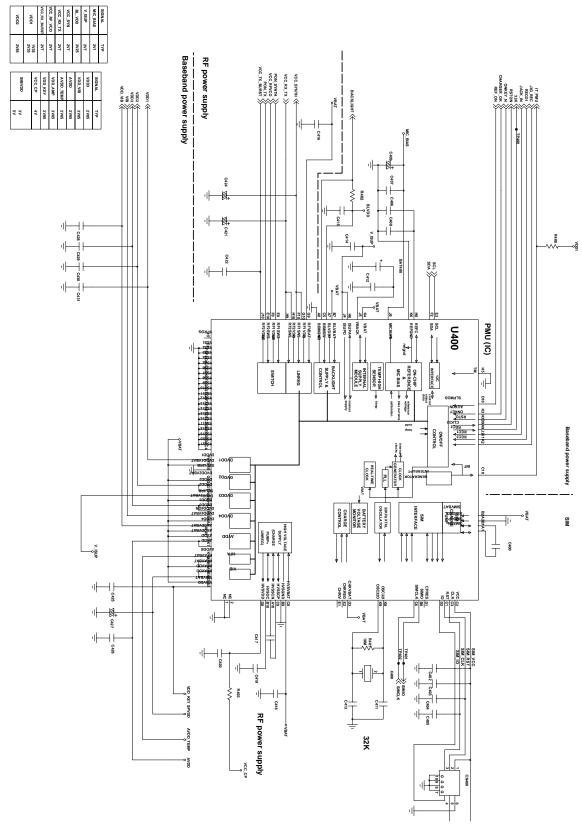


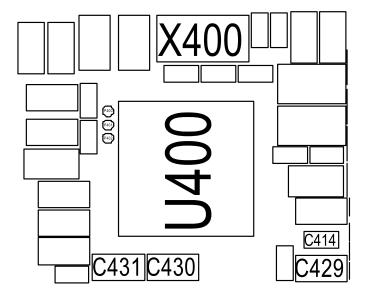
7. Flow Chart of Troubleshooting

7-1. Power On

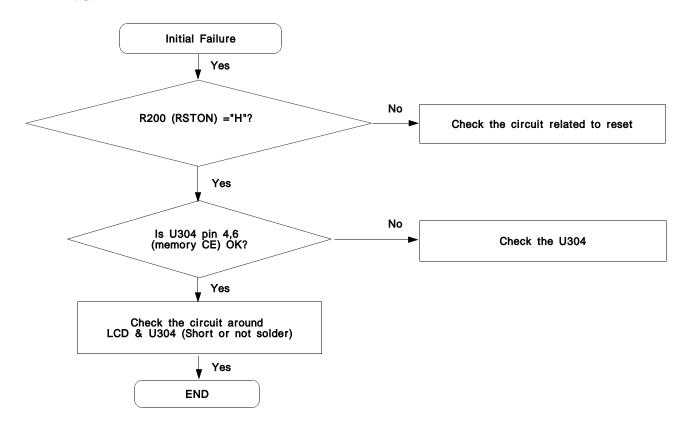


Power On

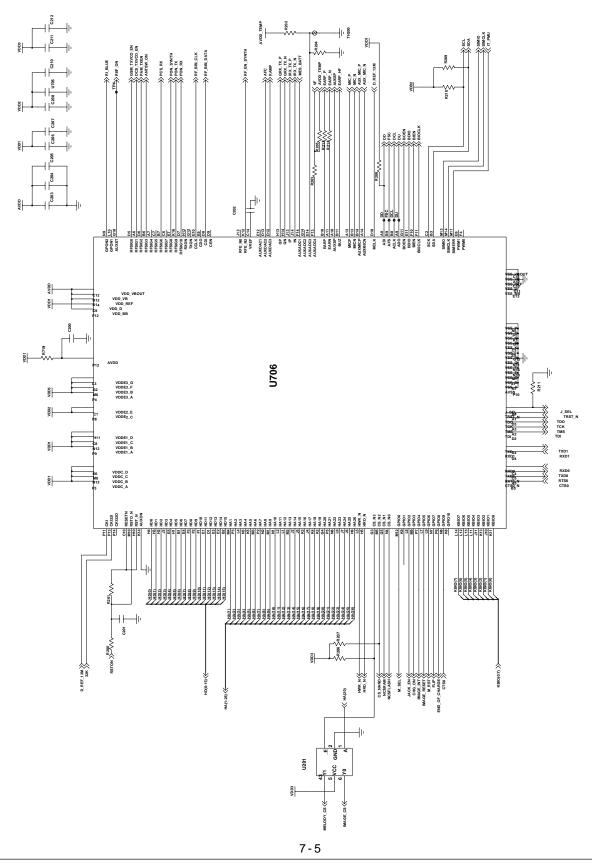


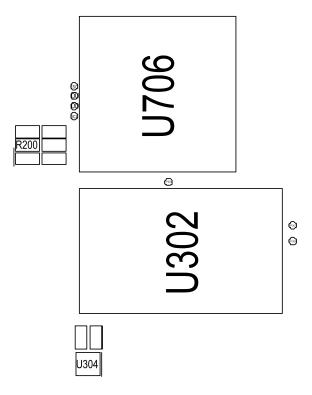


7-2. Initial

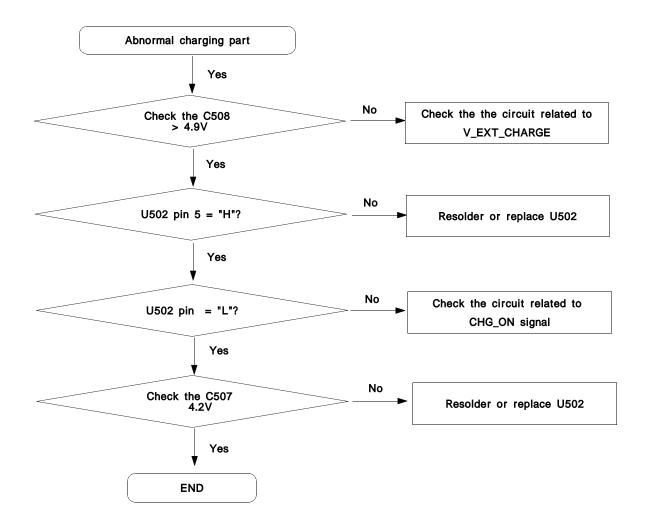


Initial

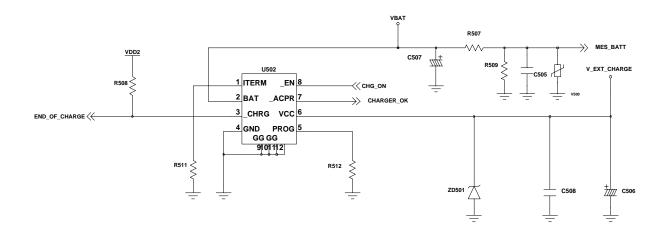


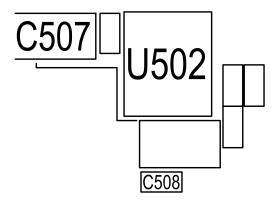


7-3. Charging Part

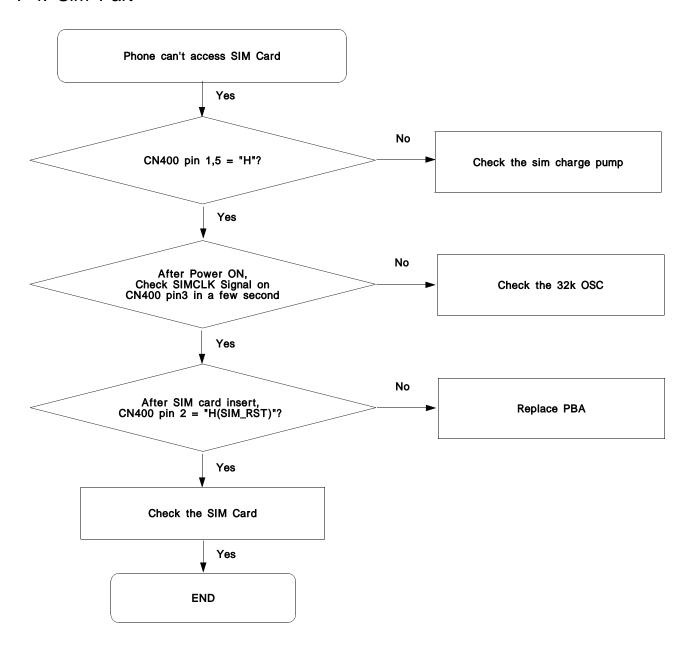


Charging

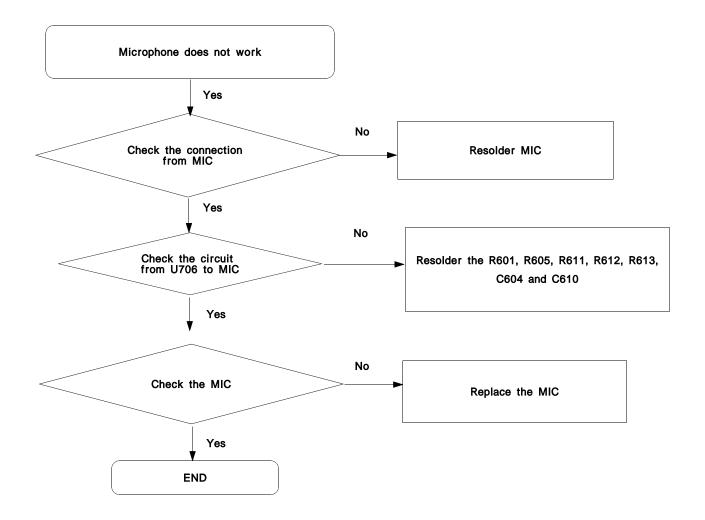


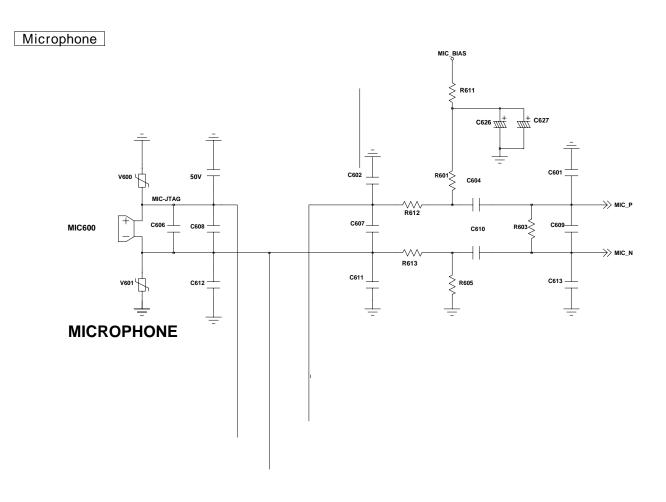


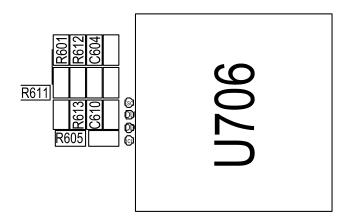
7-4. Sim Part



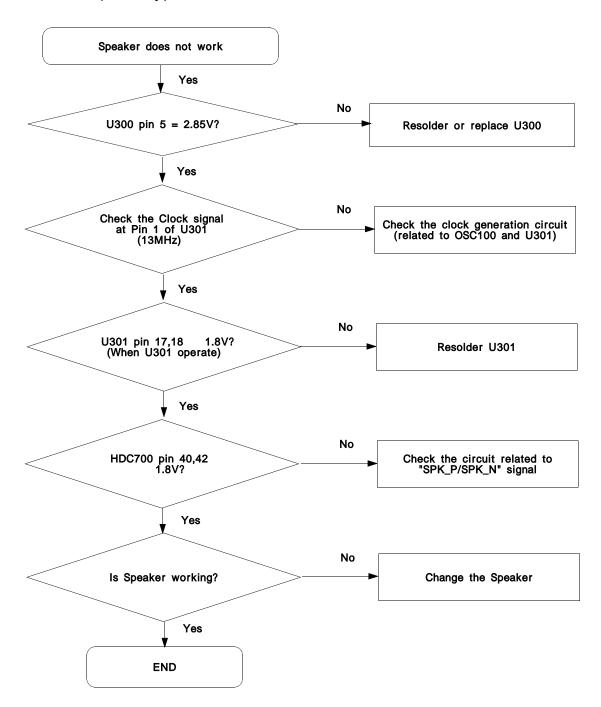
7-5. Microphone Part



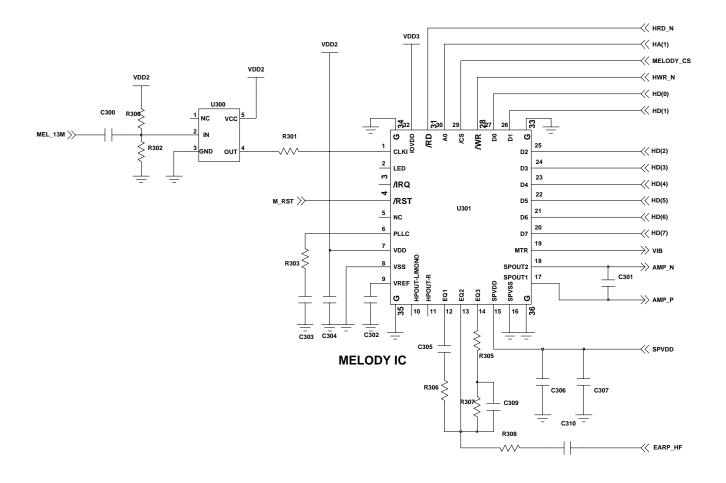


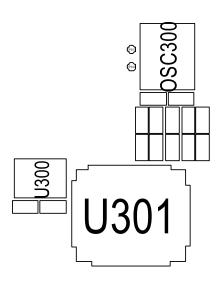


7-6. Speaker Part(Melody)

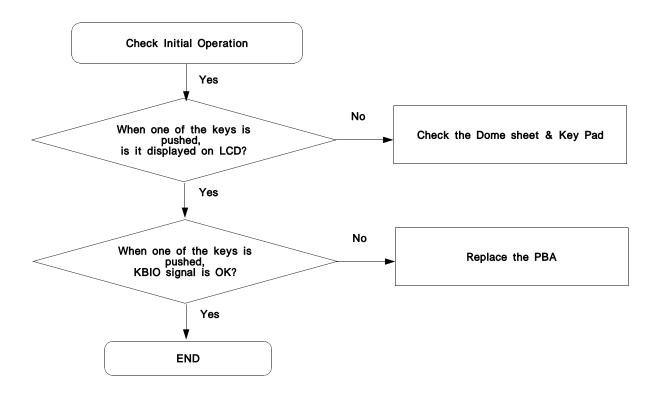


Speaker

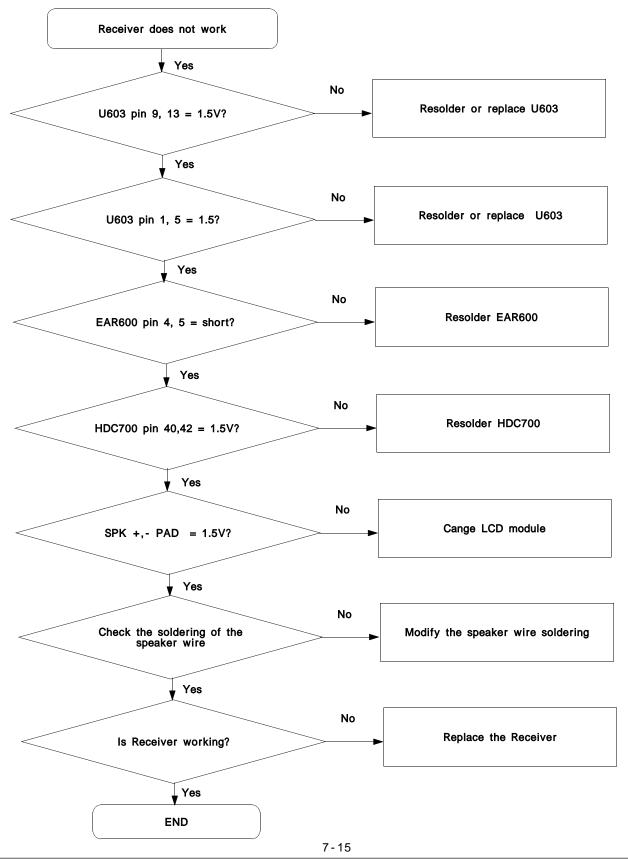




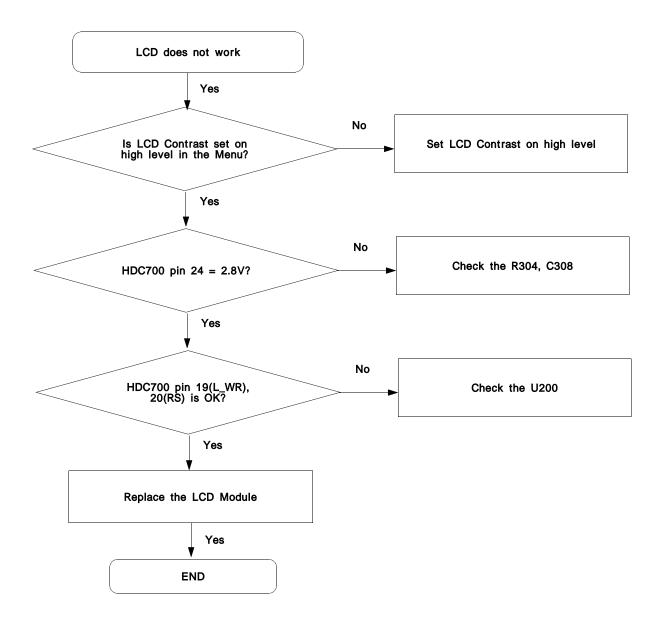
7-7. Key Data Input



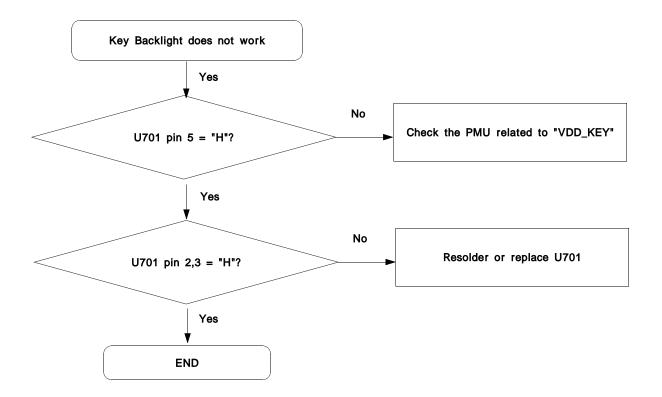
7-8. Receiver Part



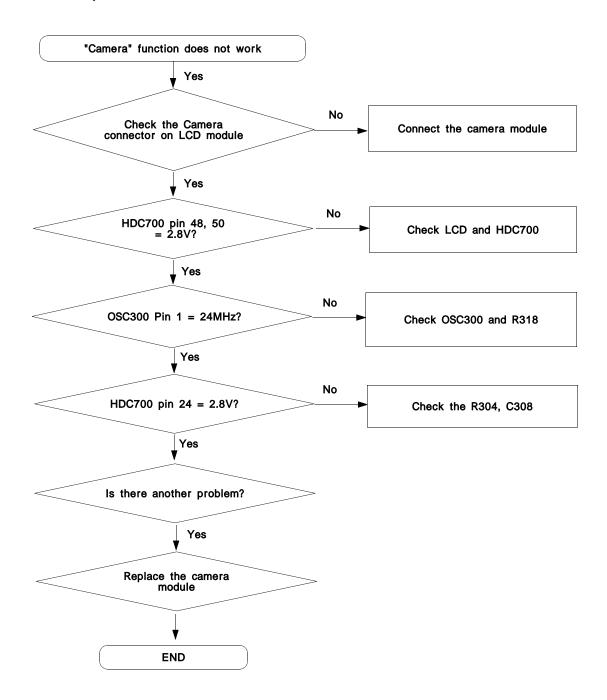
7-9. LCD Part



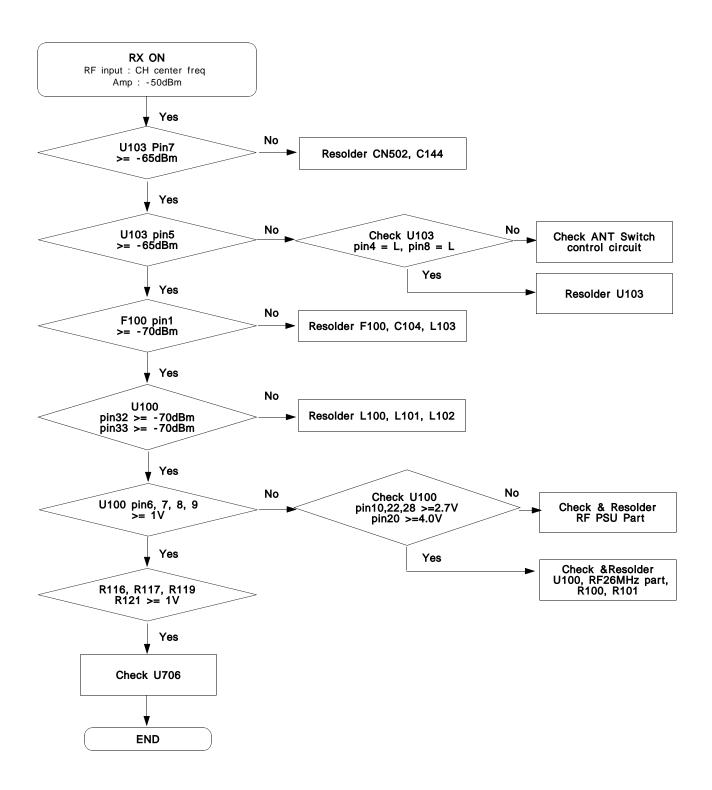
7-10. Key Back Light



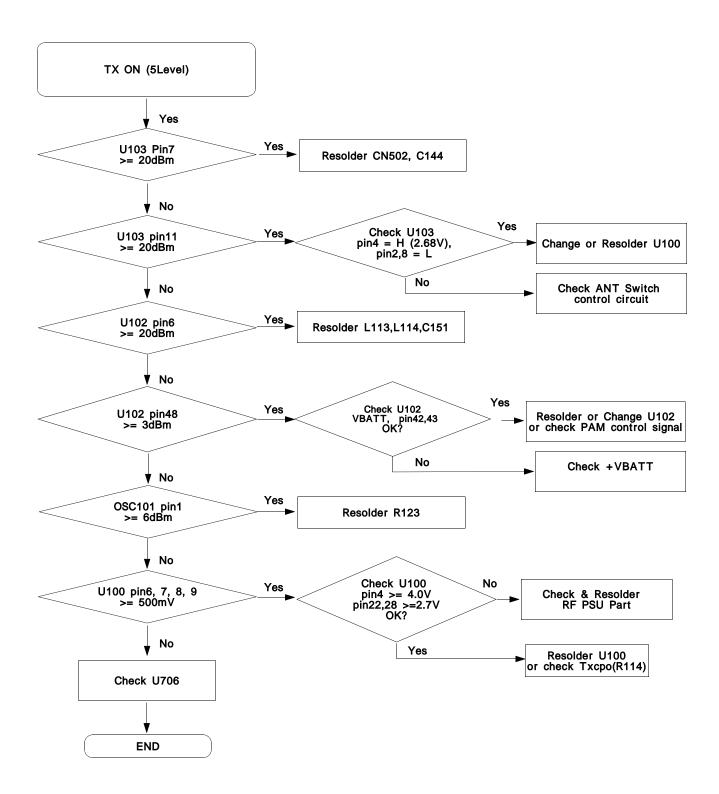
7-11. Camera part



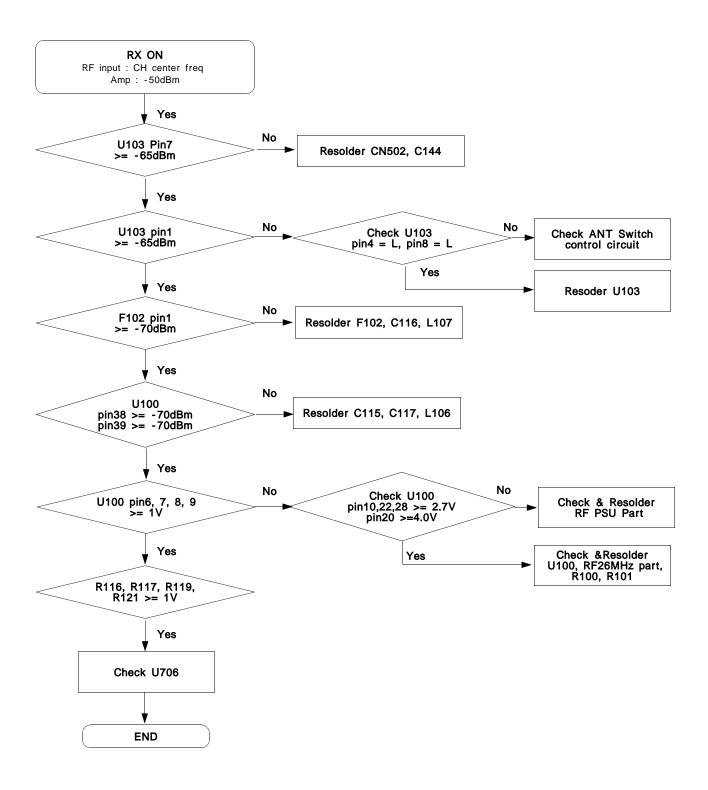
7-12. GSM Receiver



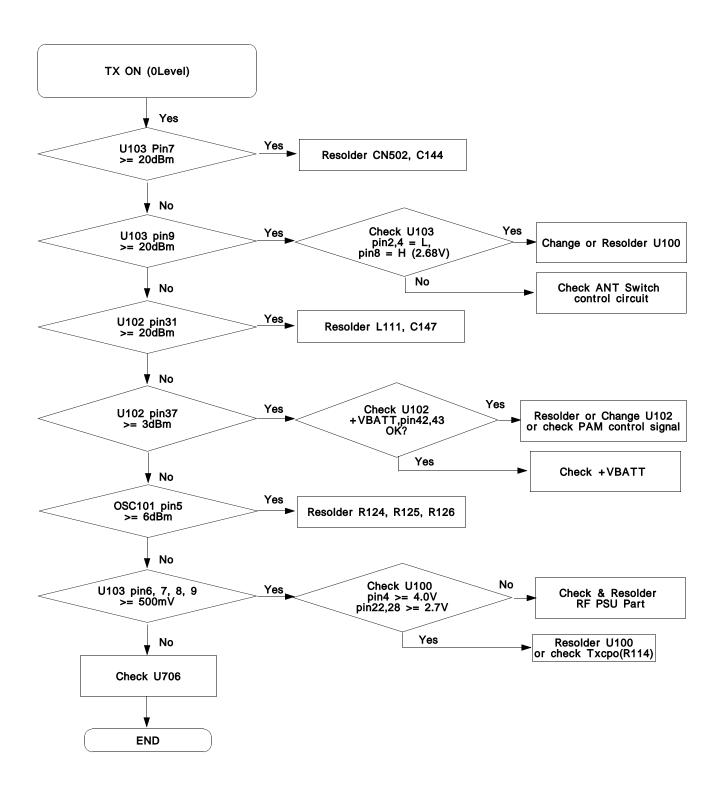
7-13. GSM Transmitter



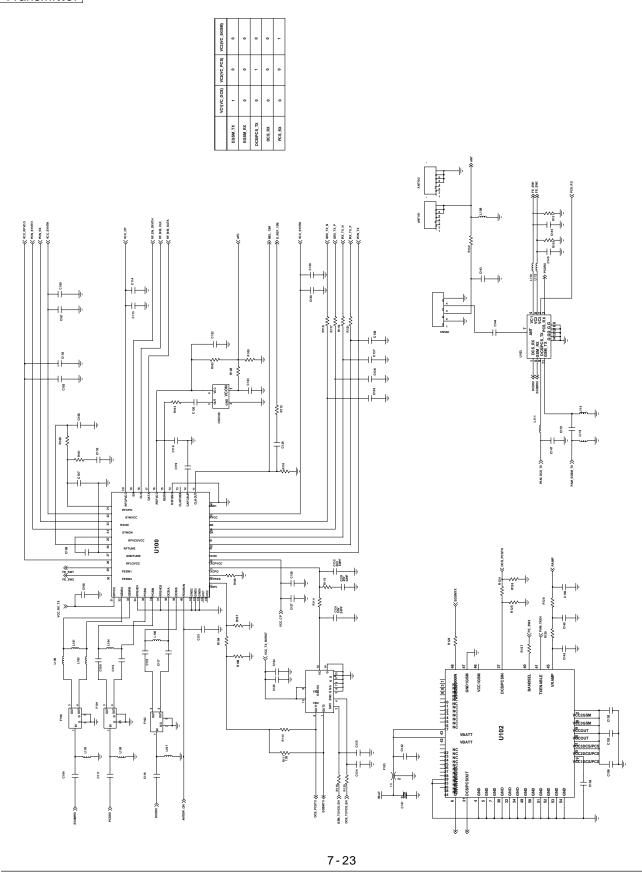
7-14. DCS Receiver

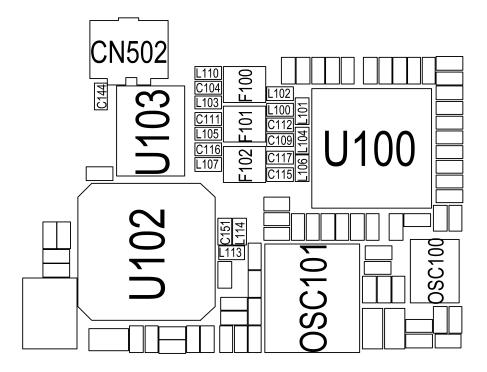


7-15. DCS Transmitter



Transmitter





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